Special Issue

Selected Papers from ICMEAS 2017

Message from the Guest Editors

This Special Issue is a compilation of the top ten papers selected from the papers presented at the 2017 International Conference on Mechanical Engineering and Automation Science (http://www.icmeas.org/), held in Birmingham, 13–15 October, 2017. This Special Issue is aimed at exhibiting the new development in the research of micromachines and/or micro-components of machines. The covered topics include desgin, modeling and simulation, material, prototyping, experiment testing, as well as automatic control. A number of practical examples are included.

Guest Editors

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Deadline for manuscript submissions

closed (31 December 2017)



Micromachines

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